Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("improvenearpackagingneardensity").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/23 09:41
L2	420	improve near packaging near density	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 09:41
S1	31	(("6731009") or ("6034425") or ("6023097") or ("6489678") or ("6627991") or ("6903458") or ("6288445") or ("6025650") or ("20020017709") or ("6573119") or ("6611063") or ("2004022510") or ("20040238954")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/28 07:55
S2	2	"08055875"	EPO; JPO; DERWENT	OR	ON	2005/12/28 09:20
S3	2	("6731009").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/28 08:53
S4	7	("5291062" | "5550403" | "5646828" | "5760478" | "5963429" | "5973392" | "6343019").PN. OR ("6731009").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/28 09:01
S5	5130	(257/738,777,778).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/23 04:43
S6	0	("5and@ad<20040205").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/28 09:01
S7	4579	S5 and @ad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 06:52

S8	1358	S5 and @rlad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/28 09:03
S9	1682	(257/777).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/28 09:03
S10	1554	S9 and @ad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:44
S11	448	S9 and @rlad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/28 09:03
S12	1610	S10 S11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/28 10:24
S13	192	(die near5 form) near15 chip	EPO; JPO; DERWENT	OR	ON	2005/12/28 09:20
S14	1496	(die near5 form) near15 chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/28 09:20
S15	44	S14 and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/28 09:21
S16	2	("6650008").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/28 10:24

S17	6	("5012323" | "5229960" | "5721452" | "5760478" | "5808878" | "6084308").PN. OR ("6650008").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/28 10:58
S18	1590	(((solder or ball or bump) near5 (side or L-shap$2 or edge)) same (die or dice)) and chip	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/28 10:59
S19	497	stack$5 and S18	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 04:46
S20	7	("5291062" | "5550403" | "5646828" | "5760478" | "5963429" | "5973392" | "6343019").PN. OR ("6731009"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 04:42
S21	3915	(257/738,778).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/23 04:44
S22	3443	S21 and @ad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:44
S23	1031	S21 and @rlad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:44
S24	3604	S22 S23	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:44
S25	261120	(die or carrier or chip or substrate) and (ball or bump)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:45
S26	3222	S24 and S25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:45

S27	791	stack$5 and S26	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 04:46
S28	792	stack$5 and S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 04:46
S29	10	("20020004258" | "20020050635" | "6144101" | "6157080" | "6229217" | "6258626" | "6274930" | "6353263" | "6445594").PN. OR ("6707143"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 05:42
S30	2	("6239496").PN. OR ("6433415"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 05:59
S31	17	("4705606" | "5604978" | "5717245" | "5729051" | "5777391" | "5783870" | "5796321" | "5869894" | "5894410" | "5900675" | "5914531" | "5914535" | "5920117" | "5926696").PN. OR ("6034425").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 06:08
S32	19	("4982265" | "5399898" | "5424245" | "5557149" | "5614766" | "5616958" | "5640051" | "5729440" | "5751060").PN. OR ("5914535"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 06:10
S33	55	("4021838" | "5647123").PN. OR ("5801447").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/23 06:37
S34	7	(("6489678") or ("6903458") or ("6288445")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/23 06:37
S35	0	("stackednear3flipnearchip").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/23 06:52

S36	243	stacked near3 flip near chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 06:52
S37	25125639	20and @ad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 06:52
S38	207	S36 and @ad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 06:52
S39	71	S36 and @rlad<"20040205"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 06:52
S40	218	S38 S39	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 06:57
S41	14	(mother adj board) and S40	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 07:02
S42	2	"08055875"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 08:11
S43	87	(mother adj board) and (daughter adj board) and (flip adj chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/23 08:14

S44	2	("5,914,535").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/23 09:41